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UNITED STATES

Docket	No.:		

As a below named inventor, I hereby de My residence, post office address and ci	tizenship are as stated below sole inventor (if only one nar imed and for which a patent	next to my name. me is listed below) or an original, first and joint inventor (if	plural names are listed
the specification of which is attached her			
on (if applicable). I hereby state that I have reviewed and u		n Number or PCT International Application Number above-identified specification, including the claims, as amount	and was amended
I hereby claim foreign priority benefit(s)	under 35 U.S.C. § 119(a)-(c	patentability as defined in 37 CFR § 1.56. d) or § 365(b) of any foreign application(s) for patent or involved in the patent or inventor is certificate having a filing date before the patent or inventor is certificate to the patent of the p	entor's certificate listed e that of the application on which
Prior Foreign Application(s)		Priority	Not Claimed
23653/2003	Japan	31/1/2003	
(Number)	(Country)	Day/Month/Year Filed	
the United States, listed below and, inso International application(s) in the manner	far as the subject matter of ear provided by the first paragr CFR § 1.56 which became	Day/Month/Year Filed y United States application(s), or § 365(c) of any PCT Inte- each of the claims of this application is not disclosed in the p- raph of 35 U.S.C. § 112, I acknowledge the duty to disclose available between the filing date of the prior application and	rnational application designating rior United States or PCT e information which is
(Application Serial No.)	(Filing Date)	(Status patented, pending, abandoned	1)
(Application Serial No.)	(Filing Date)	(Status patented, pending, abandoned	<u></u>
I hereby appoint the attorneys and ager in the Patent and Trademark Office conf		nder USPTO Customer No. 21,171 to prosecute this appli	cation and to transact all business
		21171 PATENT TRADEMARK OFFICE	
and further that these statements were r	nade with the knowledge th	edge are true and that all statements made on information nat willful false statements and the like so made are punisl nd that such willful false statements may jeopardize the	nable by fine or imprisonment, or
Full name of sole or first inventor	kira ECAWA		· .
Inventor's Signature	1 kina Egawa	Date December 11,	2003
Residence Cotenba-shi, Shiz	noka, 412-0043 Japa	an Citizenship Japanese	
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Full name of second joint inventor, if any	Minoru ANDO		
Second Inventor's Signature	Minoru Ando	Date December 11,	2003
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